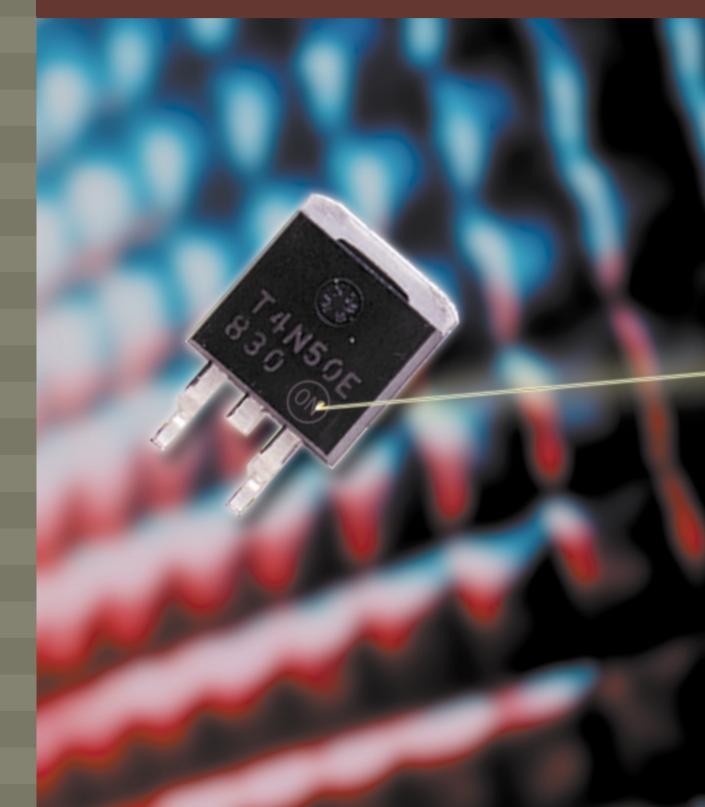
ON Semiconductor Part Marking Transition Brochure

ON Semiconductor





ON Semiconductor Part Marking Transition Brochure

BRD8008/D Rev. 0, Apr-2000



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For additional information, please contact your local Sales Representative

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Thyristors
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Line Power Analog
General Purpose Analog8
Battery Management Analog
ECL - Emitter Coupled Logic 10
Standard Logic
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Bar Code Labeling
Box Marking



ON Semiconductor

March 31, 2000

Greetings,

On August 5th, 1999 Motorola's former Semiconductor Components Group emerged as ON Semiconductor, an independent company focused on standard discrete, logic and analog semiconductor products. As part of the terms of separation ON Semiconductor was granted the ability to manufacture and sell Motorola logo-marked products for one year. Per the terms of the agreement ON Semiconductor will cease placing the Motorola mark on product on August 5, 2000. ON Semiconductor will continue to sell existing Motorola marked inventory until it is depleted or August 5, 2001. In place of the Motorola "batwing" and other Motorola trademark markings, ON Semiconductor will begin marking products as well as intermediate packaging with the ON Semiconductor logo (see sample representation included in this package) beginning July 15, 2000. Even though no Motorola-marked product will be produced after August 5, 2000, we will continue to ship existing inventory leading to the possibility of receiving mixed shipments containing both ON Semiconductor and Motorola marked product.

This communication package has been developed to provide you detailed information regarding the transition from Motorola marking to ON Semiconductor marking. Enclosed you will find the following:

- Formal PCN Notification
- Representative Diagram of new 'ON' marking
- Photographed comparison of Motorola and ON marked devices
- Photographs of new ON Semiconductor intermediate packaging containers

There will be no change in the manufacturing process of the products and the new marking will not effect the performance of the part in any way. We appreciate your continued support in helping us make ON Semiconductor the premier semiconductor component manufacturer in the world.

Sincerely,

Beil Sur

Bill George



NOTIFICATION / PCN

ON Semiconductor

5005 E. McDowell Road Phoenix, AZ 85008 http://onsemi.com

Please read the following notification on the marking of ON Semiconductor product, issued on Feb. 14, 2000.

1 ************************************	* * * * * * * * * * * * * * * * * * * *
_	ENTS - MASTER FORMAT
**************************************	* * * * * * * * * * * * * * * * * * * *
PLANNED ISSUE DATE: 14-Feb-2000 PLANNED EFFECT DATE: 15-Feb-2000	
CREATE DATE: 14-Feb-2000	LAST UPDATE DATE: 14-Feb-2000
ISSUING DIVISION:ON SEMICONDUCTOR ADMINISTRATOR: JOAN KEARNEY-HOPKINS USERID: RYAG70	PHONE: 602-244-3584
DELIVERY METHOD OVERRIDE: N ALL AFFECTED CUSTOMER NOTIFIED: N	
TITLE: ON LOGOS TO REPLACE MOTOROLA AND DEVICES	LOGOS ON PACKAGING MATERIALS
E01 TITLE: ON LOGOS FOR PKG MATRLS	& DEVS
AFFECTED CHANGE CATEGORIES Shipping/Packaging Materials	
AFFECTED PRODUCT DIVISIONS MOS POWER PRODUCTS DIV BIPOLAR DISCRETES PRODUCTS DIV	ANALOG PRODUCTS DIV LOGIC PRODUCTS DIV
ADDITIONAL RELIABILITY DATA: None REFERENCE: PHONE:	USERID:
SAMPLES: No REFERENCE: PHONE:	USERID:

NOTIFICATION DATA REFERENCE:JON WHITCOMB PHONE: 602-244-5394

USERID:RHPF30

DISCLAIMER DESCRIPTION AND PURPOSE

ON Semiconductor will begin the changeover from the Motorola logo to the ON Semiconductor logo for packaging materials on May 15, 2000 and for part marking on July 15, 2000. This General Announcement affects all ON Semiconductor part numbers.

Motorola logos will be removed from bar code labels and will not be replaced with the ON logo (ON Semi bar code labels will be "plain").

For a period of time, you may receive mixed shipments of ON Semiconductor and Motorola bar code labels, packaging and parts.

PART MARKING:

1

PACKAGING MATERIAL:

The Motorola logo on packaging material will be changed to the ON Semiconductor logo.

BAR CODE LABELS:

The Motorola logo on intermediate bar code labels will be removed and not replaced with ON Semiconductor logo.

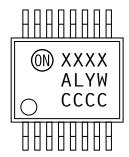
These changes will be complete by August 5, 2000. Traceability codes may also change at a later date. We will change those to improve our part tracking program. You will be notified when such changes will occur.

Marking Representations

The white lines* within the representative diagram below, define the path of the marking device required to develop the ON Logo on the face of the package. Due to the variation in each individual marking device, the "line thickness" may vary relative to the size of the logo. Tie bars may be visible when other marking devices are used.



* The white lines follow the exact centerline of each character - the surrounding circle, the letter 'O' and the letter 'N'.



DISCLAIMER: Neither image is to scale and both are only visual representations of the new marking logo.

Part Marking Cross Reference Tables, by Technology

The following tables describe all of the Motorola and ON Semiconductor device packages, their logo status, and the location of their sample representation photographs (when available) in the following pages of this brochure, listed out by technology.

MARKED WITH ON LOGO	PHOTO ON PAGE
TO-3 METAL - BIPOLAR POWER	12
TO-3 METAL DUAL DIE - BIPOLAR POWER	12
TO-218/TO-3 PLASTIC	13
PBL TO-3 PLASTIC	13
TO-3 CUSTOM POWER	13
TO-247 PLASTIC	14
TO-220 ATLAS - BIPOLAR POWER	15
NOT MARKED WITH ON LOGO	REFERENCE ON PAGE
CASE 77 PLASTIC	17
TO-220 FULL PAK - BIPOLAR POWER/MOS GATED	17
SO-8 DUAL	18
D2PAK	19
D2PAK-SURFACE MNT	19
D-PAK	19
SOT-223 EPOXY	20
RECTIFIER	
MARKED WITH ON LOGO	PHOTO ON PAGE
TO-218TO-3 PLASTIC	13
TO-247 PLASTIC	14
AXIAL LEAD - RECTIFIER	12
MICRO BUTTON - RECTIFIER	12
POWERTAP™ 2 - RECTIFIER	12
POWERTAP 3 - RECTIFIER	12
SURGE SUPRESSOR - RECTIFIER	12
SURMETIC™ 3 AMP- RECTIFIER	12
SUB-SURMETIC 3 AMP - RECTIFIER	12
SURMETIC 1 AMP - RECTIFIER	13
TOP CAN - RECTIFIER	N/A
SUB SURMETIC 1 AMP - RECTIFIER	13
SURFACE MOUNT SURGE SUPRESSOR - RECTIFIER	12
TO-218 SCHOTTKY PLASTIC - RECTIFIER	13
NOT MARKED WITH ON LOGO	REFERENCE ON PAGE
TO-220 FULL PAK - BIPOLAR POWER/MOS GATED/R	ECTIFIER 17
D2PAK	19
D2PAK - SURFACE MOUNT	19
D-PAK	19
TO-220 DUAL - RECTIFIER	17
SURFACE MOUNT C	20
SOIC 8-LEAD	18

RECTIFIER (cont.)

NOT MARKED WITH LOGO	REFERENCE ON PAGE
SMB - SURFACE MOUNT B 37MIL	22
SURFACE MOUNT A	22
CAN BUTTON - RECTIFIER	N/A
SOD-123	N/A
JUMBO BUTTON - RECTIFIER	N/A
TAB MOUNT - RECTIFIER	N/A
POWERMITE™	N/A

THYRISTORS

MARKED WITH ON LOGO	PHOTO ON PAGE
SIDAC 3 AMP	12
SIDAC 1 AMP	15
TO-220 ATLAS - THYRISTOR	15
TO-220 CLIP MANUAL	16
TO-220 CLIP AUTO	16
TO-220 FULL PAK - THYRISTOR	16

NOT MARKED WITH ON LOGO

NOT MARKED WITH ON LOGO	REFERENCE ON PAGE
D-PAK	19
SMB - SURFACE MOUNT B 37MIL	22
CASE 77 PLASTIC	17
SOT-223 EUTETIC	20
SSOVP BUTTON - THYRISTOR	N/A
TO-92 THYRISTOR/T. DIODE	N/A

SMALL SIGNAL

NOT MARKED WITH ON LOGO	REFERENCE ON PAGE
SOT-223 EUTETIC	20
TO-92 THYRISTOR/T. DIODE	N/A
SOD-123	N/A
SOIC 16-LEAD	18
TO-92 GP	21
TO-92 SMALL SIGNAL	21
TO-92 1 WATT	21
SC-59	N/A
SOT-23 D	N/A
SOT-23 LC	N/A
SC-74 TRANSISTOR	N/A
SC-70	N/A
SC-88	N/A
SOT-89 TRANSISTOR	N/A
SC-75	N/A
SOT-23S	N/A
SC-70 D	N/A
TSOP-6 EPOXY	N/A
TSOP-6 EUTETIC	N/A
S0D-323	N/A

ZEI

ZENER	
MARKED WITH ON LOGO	PHOTO ON PAGE
SURMETIC 40	12
SURMETIC 40 CLIPPERS	12
SURMETIC 40 CLIPPER DUAL	12
MOSORB™	13
MiniMOSORB™	13
MOSORB DUAL	13
MiniMOSORB DUAL	13
MOSORB CLIPPER	13
MiniMOSORB CLIPPER	13
SURMETIC 30	15
NOT MARKED WITH ON LOGO	REFERENCE ON PAGE
SOD-123	N/A
SC-74 TRANSISTOR	N/A
SOT-23S	N/A
SOD-323	N/A
SMB - SURFACE MOUNT B 37MIL	22
SURFACE MOUNT C	20
SURFACE MOUNT A	22
POWERMITE	N/A
DO-35 0.5 WATT - ZENER	21
DO-41 1 WATT - ZENER	21
SURFACE MOUNT A CLIPPER	22
SURFACE MOUNT B 60MIL	22
SURFACE MOUNT B 60MIL CLIPPER	22
SOT-23 DUAL ZENER	N/A
MOS GATED	
MARKED WITH ON LOGO	PHOTO ON PAGE
TO-247 PLASTIC	14
PBL TO-3 PLASTIC	13
TO-220 ATLAS - MOS GATED	15
TO-3 PLASTIC DUALDIE	13
TO-247 PLASTIC DUALDIE	14
PDIP 16-LEAD DUALDIE	14

D3PAK - TMOS

NOT MARKED WITH ON LOGO	EFERENCE ON PAGE
SOT-23S	N/A
SOT-223 EUTETIC	20
TO-92 SMALL SIGNAL/MOS GATED	21
TO-92 1 WATT	21
SOT-23 LC	N/A
SC-70	N/A
TSOP-6 EPOXY	N/A
TSOP-6 EUTETIC	N/A
D-PAK	19
TO-220 FULL PAK - BIPOLAR POWER/MOS GATED/REC	TIFIER 17

N/A

MOS GATED (cont.)

NOT MARKED WITH ON LOGO	REFERENCE ON PAGE
D2PAK	19
D2PAK - SURFACE MOUNT	19
SO-8 DUAL	18
SOT-223 EPOXY	20
Micor8™ 3.0L*3.0W .65P	17
Micro8 DUAL	17
SO-8 SINGLE MOS GATED	18
SO-8 COMPLEMENTARY MOS GATED	18
SOEIAJ 20-LEAD T2	19
TSSOP8 3.0L*4.4W .65P	18

Analog by Functionality

LINE POWERED ANALOG

MARKED WITH ON LOGO	PHOTO ON PAGE
PDIP 24-LEAD NARROW	12
PDIP 8-LEAD	14
PDIP 14-LEAD	14
PDIP 16-LEAD	14
PDIP 18-LEAD	14
CDIP 08-LEAD	14
TO-220 5-LEAD STRAIGHT	15
TO-220 5-LEAD STAGGER	15
PDIP 20-LEAD	15
SOIC 16-LEAD WIDE	16
SOIC 20-LEAD WIDE	16
SOIC 24-LEAD WIDE	16

NOT MARKED WITH ON LOGO	REFERENCE ON PAGE
SOT-23S	N/A
SOT-223 EUTETIC	20
SOEIAJ 20-LEAD T2	19
SOIC 16-LEAD	18
TO-92 GP	21
SOIC 8-LEAD	21
TO-220 ATLAS - ANALOG	18
SOIC 14-LEAD	18
SOEIAJ 14-LEAD T2	19
TSSOP 20-LEAD 6.5*4.4*1.0P.65	20
SOT-223 ANALOG	21
D2PAK 5-LEAD	22
CHIPS SM <50000 SQ MILS	N/A

GENERAL PURPOSE ANALOG

MARKED WITH ON LOGO	PHOTO ON PAGE
PDIP 8-LEAD	14
PDIP 14-LEAD	14
PDIP 16-LEAD	14

GENERAL PURPOSE ANALOG (cont.)

MARKED WITH ON LOGO	PHOTO ON PAGE
PDIP 18-LEAD	14
TO-220 5-LEAD STRAIGHT	15
SOIC 16-LEAD WIDE	16
SOIC 20-LEAD WIDE	16
SOIC 24-LEAD WIDE	16
SOIC 28-LEAD WIDE	16
LQFP 32-LEAD .8P 1.4 7*7	17

NOT MARKED WITH ON LOGO	REFERENCE ON PAGE
SOIC 16-LEAD	18
SOIC 8-LEAD	21
TO-220 ATLAS - ANALOG	18
SOIC 14-LEAD	18
SOEIAJ 14-LEAD T2	19
TSSOP 20-LEAD 6.5*4.4*1.0P.65	20
SOT-223 ANALOG	21
D2PAK 5-LEAD	22
CHIPS SM <50000 SQ MILS	N/A
TSOP-6 EPOXY	N/A
Micro8 3.0L*3.0W .65P	17
TO-220 5 STANDARD	18
SOEIAJ 16-LEAD T2	19
TSSOP 14-LEAD 5.0L*4.4W .65P	19
TO-923 ANALOG	N/A
D-PACK	19
D2PAK 3-LEAD	22
D-PAK 3LEAD STRAIGHT	N/A
SC-82AB	N/A
TSOP-5 EPOXY	N/A
SOEIAJ 8-LEAD T2	N/A
SOT-23L	N/A

BATTERY MANAGEMENT-ANALOG

MARKED WITH ON LOGO	PHOTO ON PAGE
PDIP 8-LEAD	14
SOIC 20-LEAD WIDE	16
SOIC 24-LEAD WIDE	16
LQFP 32-LEAD .8P 1.4 7*7	17
TQFP 32-LEAD .8P 1.0T 7*7	17

NOT MARKED WITH ON LOGO

SOIC 8-LEAD TSSOP 20-LEAD 6.5*4.4*1.0P.65 CHIPS SM <50000 SQ MILS TSOP-6 EPOXY Micro8 3.0L*3.0W .65P TSSOP 14-LEAD 5.0L*4.4W .65P SOEIAJ 8-LEAD T2

REFERENCE ON PAGE...

21
20
N/A
N/A
17
19
N/A

BATTERY MANAGEMENT-ANALOG (cont.)

NOT MARKED WITH ON LOGO	REFERENCE ON PAGE
SC-70	N/A
TSOP-6 EUTETIC	N/A
TSSOP8 3.0L*4.4W .65P	18
SC-88	N/A
SOT-89	N/A
TSSOP 16-LEAD 5.0L*4.4W .65P	20
TSSOP 24-LEAD 7.8L*5.6W .65P	20
SC-82	N/A
SOT-23 TRANSISTOR SMP	N/A
SOT-236 3.0*1.7*1.3P0.9	N/A

Logic - ECL and Standard Families

ECL - EMITTER COUPLED LOGIC

MARKED WITH ON LOGO	PHOTO ON PAGE
SOIC 20-LEAD WIDE	16
LQFP 32-LEAD .8P 1.4 7*7	17
PDIP 14-LEAD	14
PDIP 16-LEAD	14
PDIP 24-LEAD NARROW	12
PDIP 20-LEAD	15
CDIP 24-LEAD NARROW	13
CDIP 14-LEAD	14
CDIP 16-LEAD	15
CDIP 20-LEAD	15
GTLCC 80-LEAD 11.4*11.4*1.0	N/A
PLCC 28-LEAD	16
LQFP 52-LEAD .65P 1.4 10*10	17

NOT MARKED WITH ON LOGO	REFERENCE ON PAGE
SOIC 8-LEAD	21
TSSOP 20-LEAD 6.5*4.4*1.0P.65	20
CHIPS SM <50000 SQ MILS	N/A
SOIC 16-LEAD	18
SOEIAJ 14-LEAD T2	19
SOEIAJ 16-LEAD T2	19
SOEIAJ 20-LEAD T2	19
TSSOP-8 3.0L*3.0W .65P	18
PLCC 20-LEAD	19
CLCC 52-LEAD CU	22
GTLCC 12-LEAD 4*4*1.0 NSP	N/A

STANDARD LOGIC

MARKED WITH ON LOGO	PHOTO ON PAGE
SOIC 20-LEAD WIDE	16
PDIP 14-LEAD	14
PDIP 16-LEAD	14
PDIP 24-LEAD NARROW	12

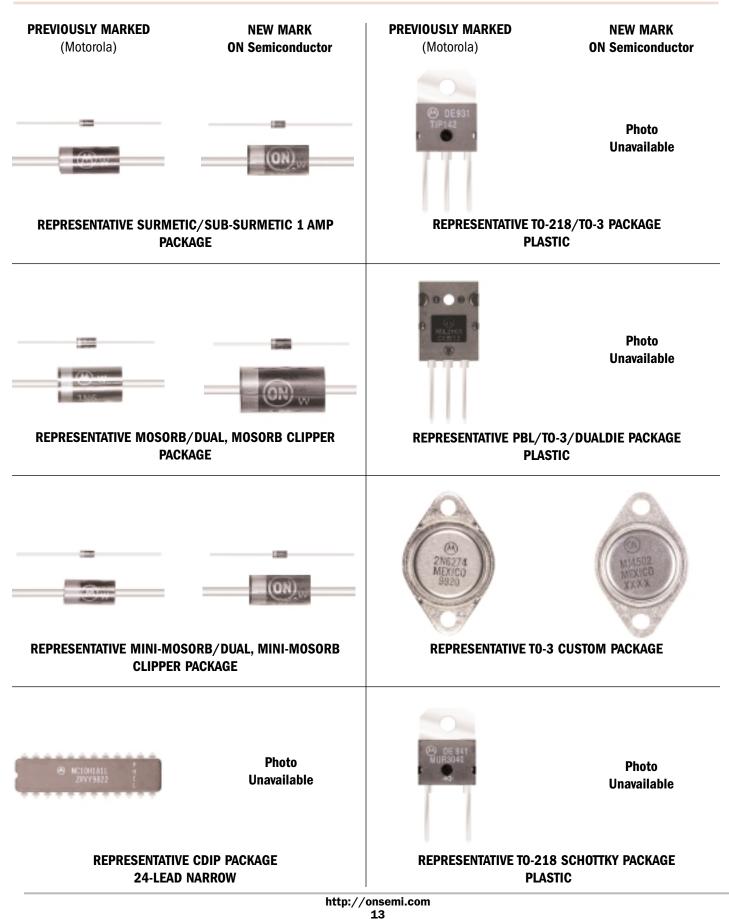
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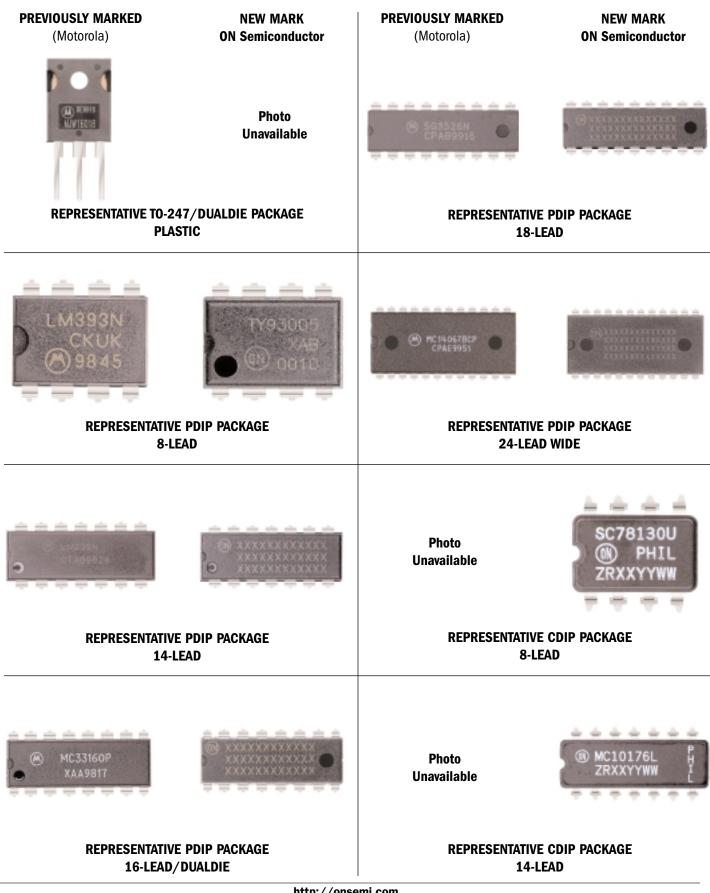
MARKED WITH ON LOGO	PHOTO ON PAGE
PDIP 20-LEAD	15
CDIP 24-LEAD NARROW	13
CDIP 14-LEAD	14
CDIP 16-LEAD	15
CDIP 20-LEAD	15
PDIP 8-LEAD	14
SOIC 24-LEAD WIDE	16
PDIP 18-LEAD	14
SOIC 16-LEAD WIDE	16
PDIP 24-LEAD WIDE BODY	14
PDIP 20-LEAD H	16

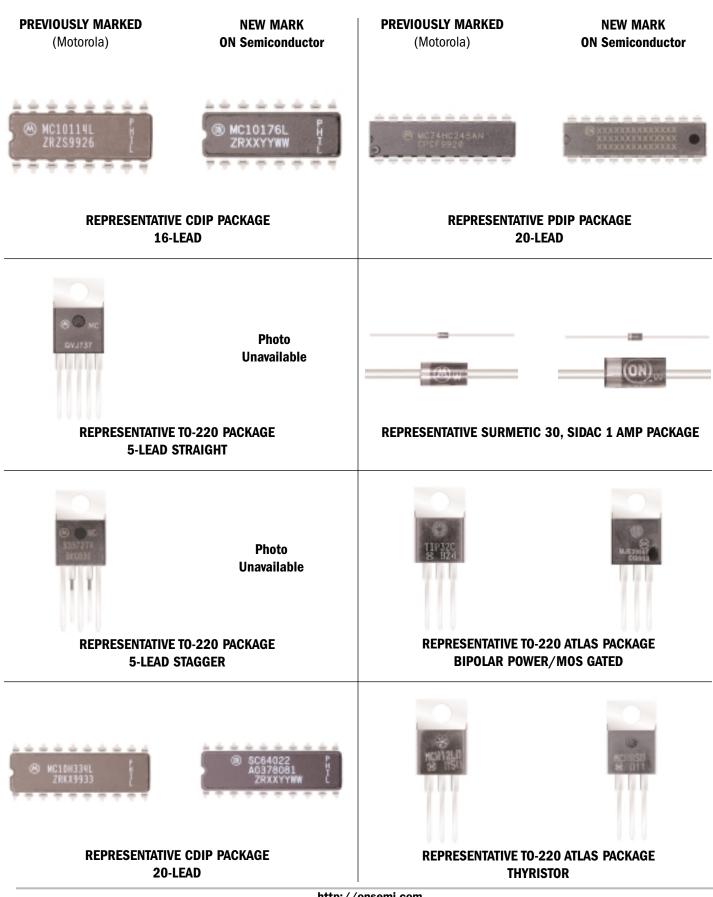
NOT MARKED WITH ON LOGO	REFERENCE ON PAGE
SOIC 8-LEAD	21
TSSOP 20-LEAD 6.5*4.4*1.0P.65	20
CHIPS SM <50000 SQ MILS	N/A
SOIC 16-LEAD	18
SOEIAJ 14-LEAD T2	19
SOEIAJ 16-LEAD T2	19
SOEIAJ 20-LEAD T2	19
TSSOP 14-LEAD 5.0L*4.4W .65P	19
SOEIAJ 8-LEAD T2	N/A
TSSOP 16-LEAD5.0L*4.4W .65P	20
SOIC 14-LEAD	18
TSSOP 24-LEAD 7.8L*4.4W .65P	20
TSSOP 48-LEAD 12.5L*6.1W .5P	20
SSOP 14-LEAD	N/A
SSOP 20-LEAD	N/A
SC-88 5-LEAD	N/A
SOT-2305 3*1.8*1.3P0.95	N/A

Photographed Marking Representations

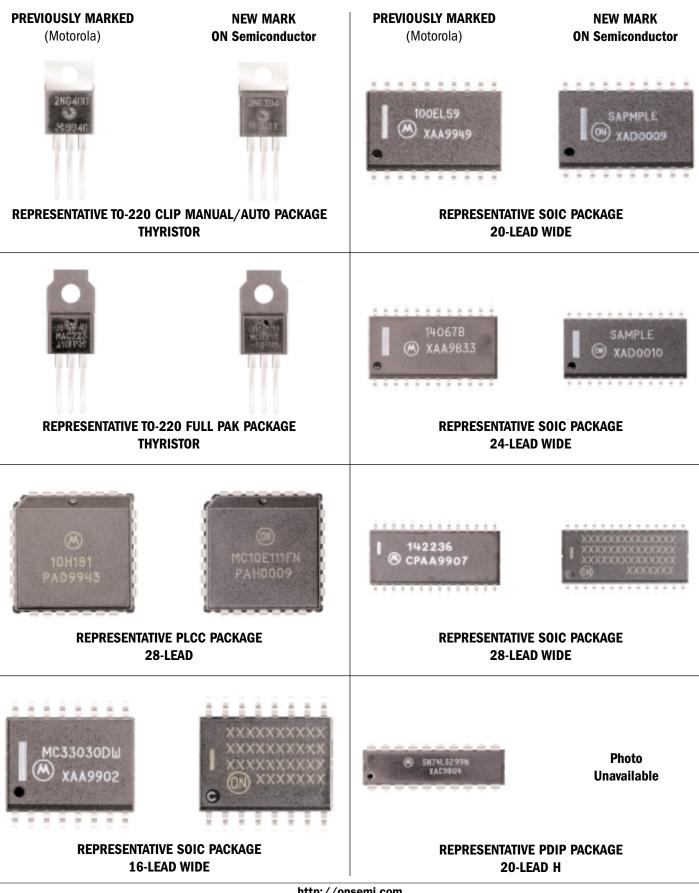








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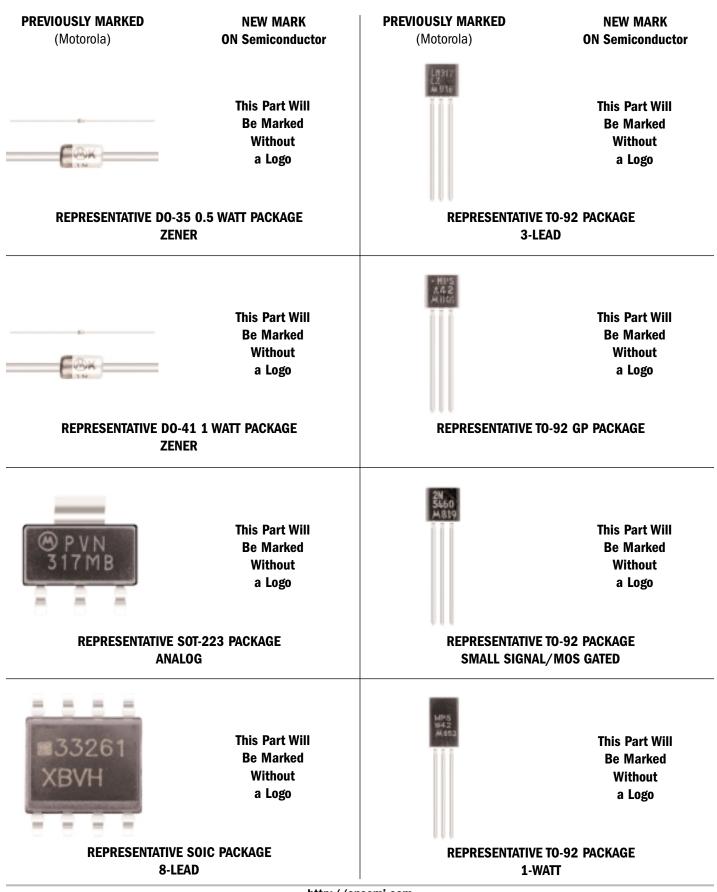
http://onsemi.com 16

<u> </u>			
PREVIOUSLY MARKED (Motorola)	NEW MARK ON Semiconductor	PREVIOUSLY MARKED (Motorola)	NEW MARK ON Semiconducto
Photo Unavailable	() 53A92 XDH0010	CO DI AD	This Part Will Be Marked Without a Logo
REPRESENTATIVE LQFP PACKAGE 32-LEAD		REPRESENTATIVE Micro8™ PACKAGE	
Photo Unavailable REPRESENTATIVE 32-LE		COGT BB REPRESENTATIVE Micr	This Part Will Be Marked Without a Logo ro8™ DUAL PACKAGE
MC100LVE 222 XAF9935 REPRESENTATIVE 52-LE		REPRESENTATIVE TO- RECTI	
C and	This Part Will Be Marked Without a Logo	2355 HOO4(16)	This Part Will Be Marked Without a Logo
REPRESENTATIVE CASE 77 PLASTIC PACKAGE		REPRESENTATIVE TO-220 FULL PACK PACKAGE BIPOLAR POWER/MOS GATED/RECTIFIER	

PREVIOUSLY MARKED (Motorola)	NEW MARK ON Semiconductor	PREVIOUSLY MARKED (Motorola)	NEW MARK ON Semiconductor
There are a second s	This Part Will Be Marked Without a Logo	D3N02	This Part Will Be Marked Without a Logo
REPRESENTATIVE TO-220 ATLAS PACKAGE ANALOG		REPRESENTATIVE SO-8 PACKAGE DUAL	
REPRESENTATIVE SINGLE/M		REPRESENTATIVE TO-220 5-	This Part Will Be Marked Without a Logo LEAD STANDARD PACKAGE
 ● DI AD 	This Part Will Be Marked Without a Logo	UC3845BVD	This Part Will Be Marked Without a Logo
REPRESENTATIVE TSSOP-8 PACKAGE		REPRESENTATIVE SOIC PACKAGE 14-LEAD	
M3P303	This Part Will Be Marked Without a Logo	ММРQ3904 € ххаа916	This Part Will Be Marked Without a Logo
REPRESENTATIVE SO-8 PACKAGE COMPLEMENTARY/MOS GATED		REPRESENTATIVE SOIC PACKAGE 16-LEAD	

PREVIOUSLY MARKED (Motorola)	NEW MARK ON Semiconductor	PREVIOUSLY MARKED (Motorola)	NEW MARK ON Semiconductor
T 33 N108 R850 (%)	This Part Will Be Marked Without a Logo	MC 14066B	This Part Will Be Marked Without a Logo
REPRESENTATIVE D2PAK PACKAGE		REPRESENTATIVE SOEIAJ PACKAGE 14-LEAD T2	
99 348 B251 5L A K A 🛞	This Part Will Be Marked Without a Logo	10H124 811DV	This Part Will Be Marked Without a Logo
REPRESENTATIVE D2PAK PACKAGE SURFACE MOUNT		REPRESENTATIVE SOEIAJ PACKAGE 16-LEAD T2	
0102 PAD9923	This Part Will Be Marked Without a Logo	74HC573A (18 ET	This Part Will Be Marked Without a Logo
REPRESENTATIVE PLCC PACKAGE 20-LEAD		REPRESENTATIVE SOEIAJ PACKAGE 20-LEAD T2	
949 & 0 1122	This Part Will Be Marked Without a Logo	 MC33 174 ● PBTQ 	This Part Will Be Marked Without a Logo
REPRESENTATIVE DPAK PACKAGE		REPRESENTATIVE TSSOP PACKAGE 14-LEAD	

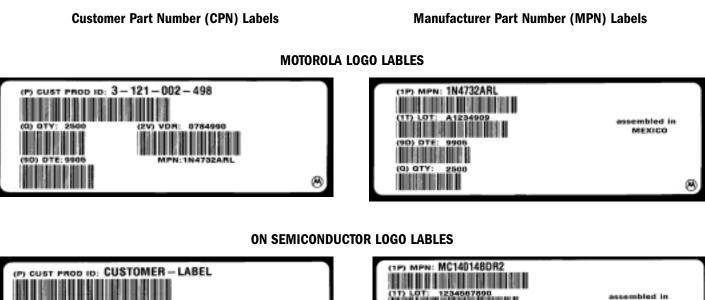




PREVIOUSLY MARKED (Motorola)	NEW MARK ON Semiconductor	PREVIOUSLY MARKED (Motorola)	NEW MARK ON Semiconductor
317MB R0947	This Part Will Be Marked Without a Logo	A R14 ZPJS+	This Part Will Be Marked Without a Logo
REPRESENTATIVE DPAK PACKAGE ANALOG		REPRESENTATIVE SMA/CLIPPER PACKAGE	
	This Part Will Be Marked Without a Logo	AB14 MG	This Part Will Be Marked Without a Logo
REPRESENTATIVE D2PAK PACKAGE 3-LEAD		REPRESENTATIVE SMB/CLIPPER PACKAGE 60MIL	
LM 2575-12 QAA907	This Part Will Be Marked Without a Logo	MC68194FJ ZRAV9823 PHILIPPINES	This Part Will Be Marked Without a Logo
REPRESENTATIVE D2PAK PACKAGE 5-LEAD		REPRESENTATIVE CLCC PACKAGE 52-LEAD	
A 922 U1B	This Part Will Be Marked Without a Logo		
	E SMB PACKAGE Mil		

Bar Code Labeling

Both the Motorola logo and ON Semiconductor logo label stock are currently being used by internal manufacturing, external manufacturing, and the global distribution centers. ON Semiconductor began the transition to no logo (blank) labels on February 15, 2000. As ON Semiconductor logo label stock is depleted, transition to the no logo (blank) labels will continue until completion on July 15, 2000. After July 15, only no logo (blank) labels will be used by ON Semiconductor. ON Semiconductor Bar Code Labeling Requirements are being revised to incorporate the no logo (blank) label.





NEW ON SEMICONDUCTOR NO-LOGO (BLANK) LABLES



Box Marking

ON Semiconductor intermediate packing box graphics will begin changing May 15, 2000 and be completed by July 15, 2000. Below are sample representations of new intermediate packaging that will be used by ON Semiconductor. ON Semiconductor Packaging requirements are being revised to incorporate the ON logo.







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